



New Product

**Si3865DV**  
Vishay Siliconix

## Load Switch with Level-Shift

PRODUCT SUMMARY		
$V_{DS2}$ (V)	$r_{DS(on)}$ ( $\Omega$ )	$I_D$ (A)
1.8 to 8	0.080 @ $V_{IN} = 4.5$ V	$\pm 2.7$
	0.110 @ $V_{IN} = 2.5$ V	$\pm 2.2$
	0.175 @ $V_{IN} = 1.8$ V	$\pm 1.7$



**ESD Protected**  
**3000 V**  
**1.8-V Rated**

### FEATURES

- 80-m $\Omega$  Low  $r_{DS(on)}$  TrenchFET™
- 1.8 to 8-V Input
- 1.5 to 8-V Logic Level Control

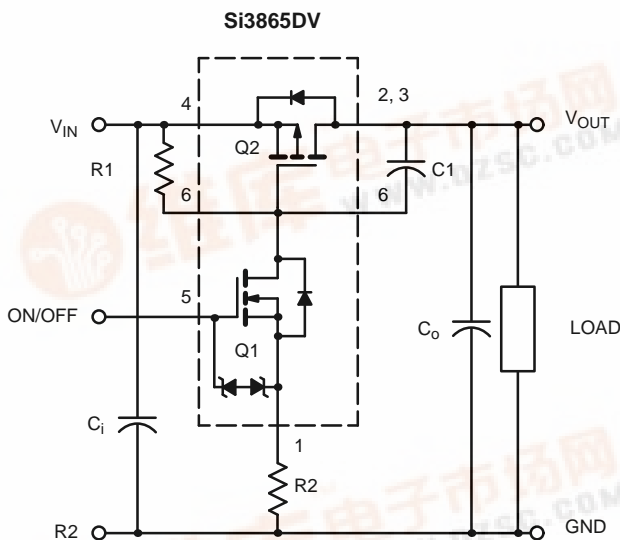
- Low Profile, Small Footprint TSOP-6 Package
- 3000-V ESD Protection On Input Switch,  $V_{ON/OFF}$
- Adjustable Slew-Rate

### DESCRIPTION

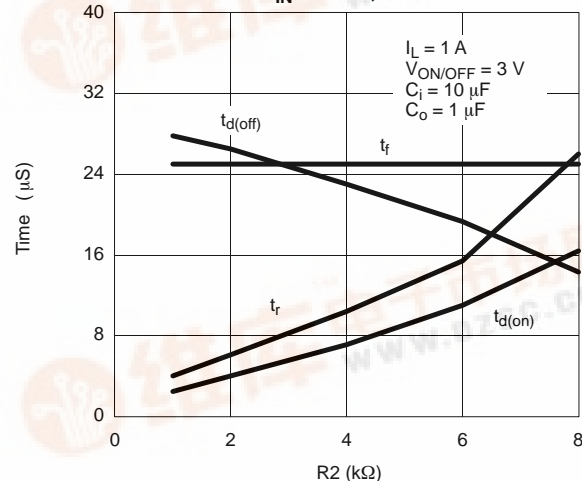
The Si3865DV includes a p- and n-channel MOSFET in a single TSOP-6 package. The low on-resistance p-channel TrenchFET® is tailored for use as a load switch. The n-channel, with an external resistor, can be used as a

level-shift to drive the p-channel load-switch. The n-channel MOSFET has internal ESD protection and can be driven by logic signals as low as 1.5-V. The Si3865DV operates on supply lines from 1.8 to 8-V, and can drive loads up to 2.7 A.

### APPLICATION CIRCUITS



Switching Variation  
R2 @  $V_{IN} = 2.5$  V, R1 = 20 k $\Omega$



Note: For R2 switching variations with other  $V_{IN}/R1$  combinations See Typical Characteristics

### COMPONENTS

Component	Description	Typical Value
R1	Pull-Up Resistor	Typical 10 k $\Omega$ to 1 m $\Omega$ *
R2	Optional Slew-Rate Control	Typical 0 to 100 k $\Omega$ *
C1, Ci	Optional Slew-Rate Control	Typical 1000 pF

\*Minimum R1 value should be at least 10 x R2 to ensure Q1 turn-on.

The Si3865DV is ideally suited for high-side load switching in portable applications. The integrated n-channel level-shift device saves space by reducing external components. The slew rate is set externally so that rise-times can be tailored to different load types.

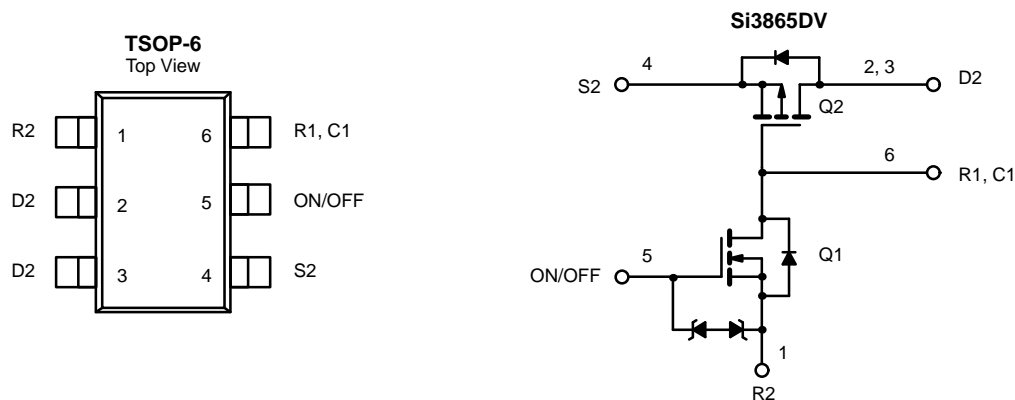
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## FUNCTIONAL BLOCK DIAGRAM



## ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	Limit	Unit
Input Voltage	$V_{IN}$	8	V
ON/OFF Voltage	$V_{ON/OFF}$	8	
Load Current	Continuous <sup>a, b</sup>	$\pm 2.7$	A
	Pulsed <sup>b, c</sup>	$\pm 6$	
Continuous Intrinsic Diode Conduction <sup>a</sup>	$I_S$	-1	
Maximum Power Dissipation <sup>a</sup>	$P_D$	0.83	W
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 to 150	$^\circ\text{C}$
ESD Rating, MIL-STD-883D Human Body Model (100 pF, 1500 $\Omega$ )	ESD	3	kV

## THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient (continuous current) <sup>a</sup>	$R_{thJA}$	120	150	$^\circ\text{C}/\text{W}$
Maximum Junction-to-Foot (Q2)	$R_{thJC}$	35	50	

## SPECIFICATIONS ( $T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

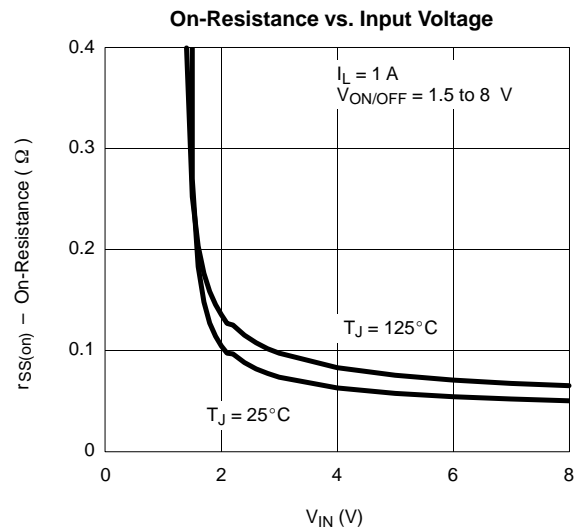
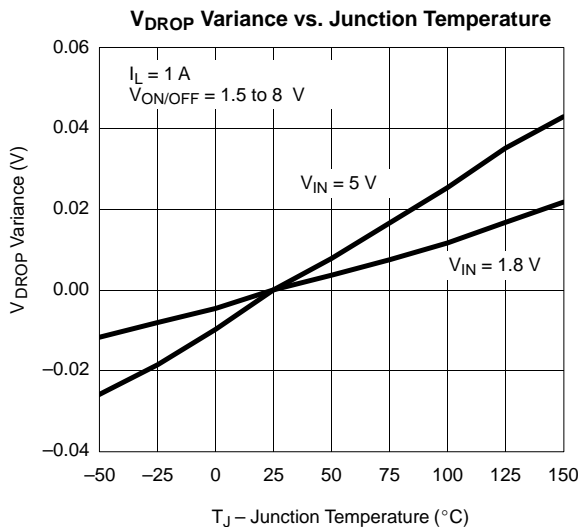
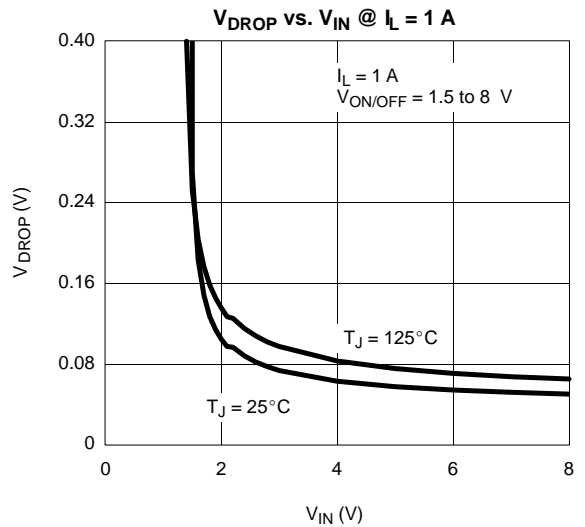
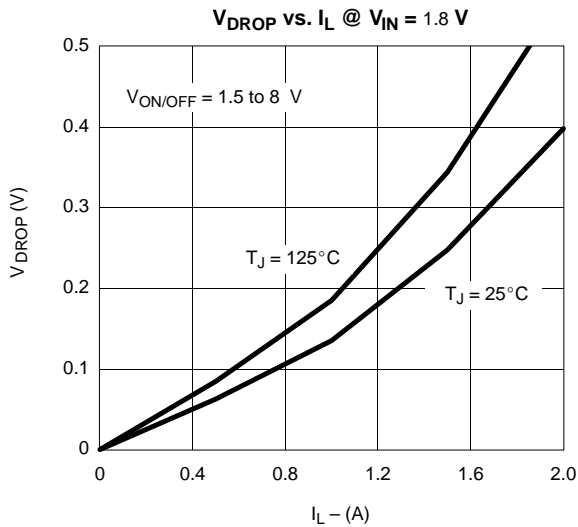
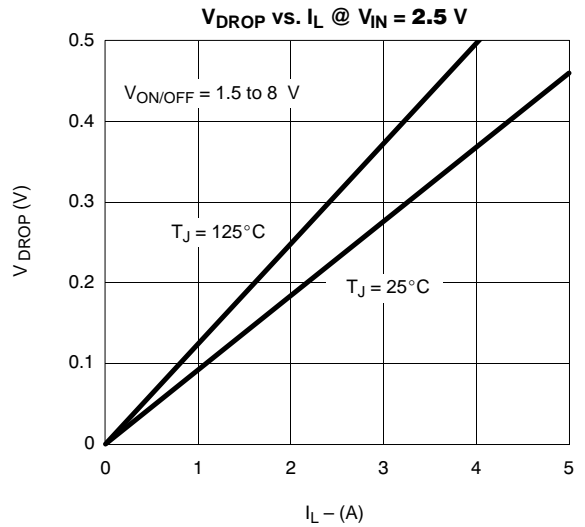
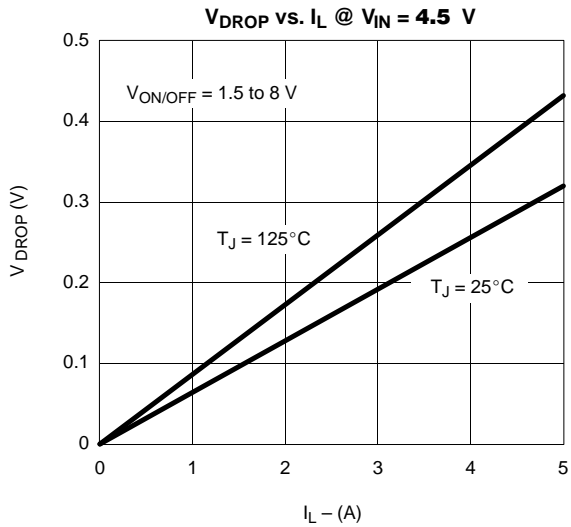
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>OFF Characteristics</b>						
Reverse Leakage Current	$I_{FL}$	$V_{IN} = 8\text{ V}, V_{ON/OFF} = 0\text{ V}$			1	$\mu\text{A}$
Diode Forward Voltage	$V_{SD}$	$I_S = -1\text{ A}$		-0.7	-1	V
<b>ON Characteristics</b>						
Input Voltage Range	$V_{IN}$		1.8		8	V
On-Resistance (p-channel) @ 1 A	$r_{DS(on)}$	$V_{ON/OFF} = 1.5\text{ V}$ $I_D = 1\text{ A}$	$V_{IN} = 4.5\text{ V}$	0.064	0.080	$\Omega$
			$V_{IN} = 2.5\text{ V}$	0.092	0.110	
			$V_{IN} = 1.8\text{ V}$	0.135	0.175	
On-State (p-channel) Drain-Current	$I_{D(on)}$	$V_{IN-OUT} \leq 0.2\text{ V}, V_{IN} = 5\text{ V}, V_{ON/OFF} = 1.5\text{ V}$	1			A
		$V_{IN-OUT} \leq 0.3\text{ V}, V_{IN} = 3\text{ V}, V_{ON/OFF} = 1.5\text{ V}$	1			

### Notes

- Surface Mounted on FR4 Board.
- $V_{IN} = 8\text{ V}, V_{ON/OFF} = 8\text{ V}, T_A = 25^\circ\text{C}$ .
- Pulse test: pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$ .

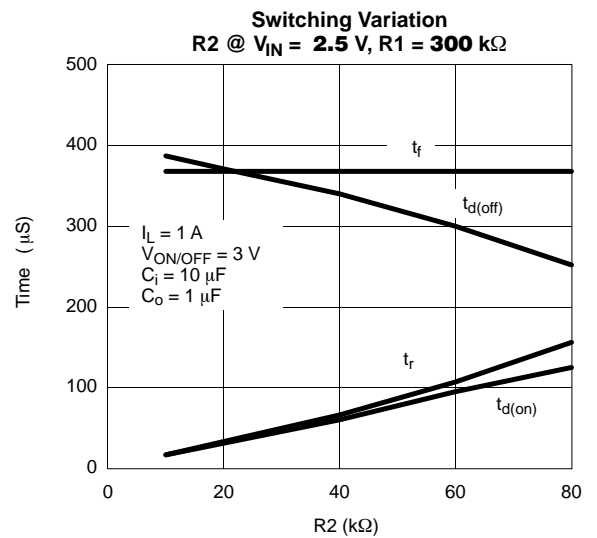
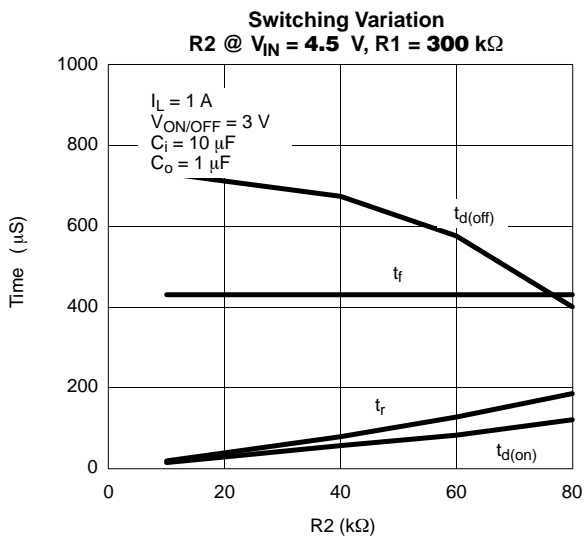
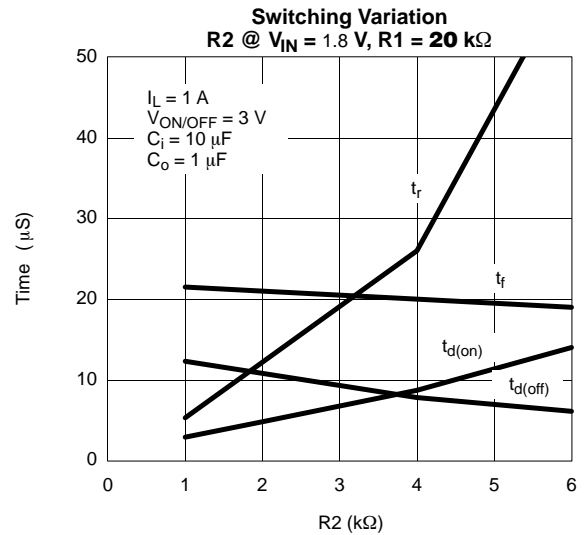
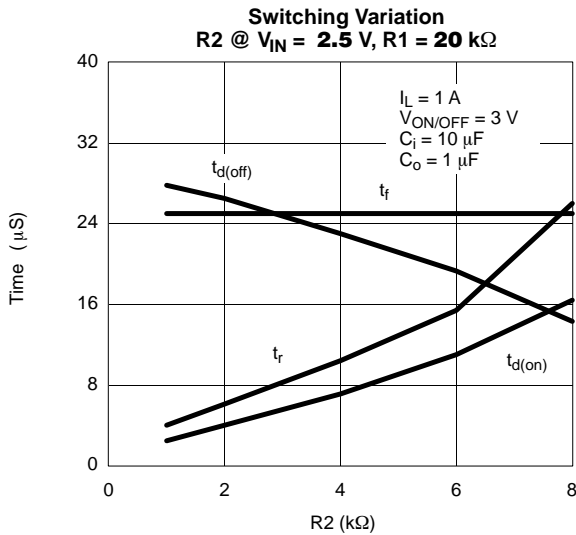
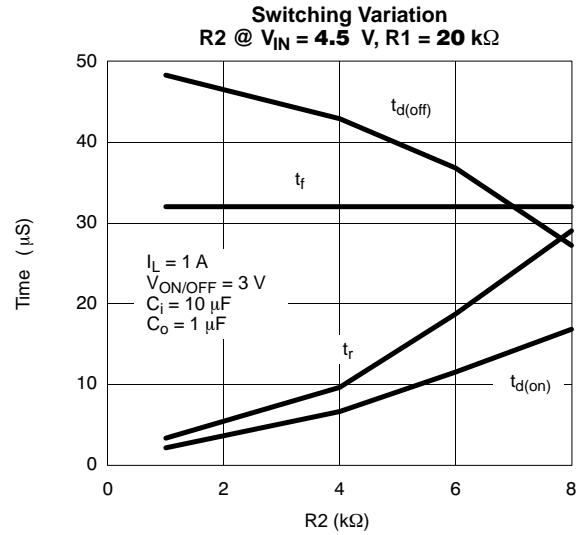
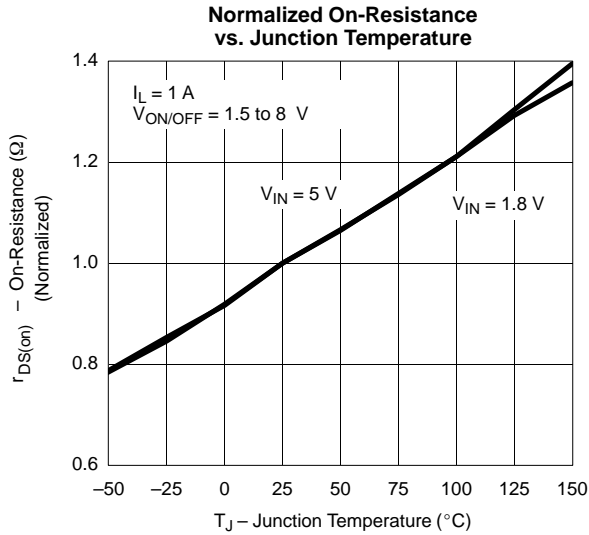


**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**





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